RICOH

0.8% Accuracy, Voltage Detector with Delay Function

NO.EA-306-160309

OUTLINE

The RP300x is a CMOS-based voltage detector (VD) IC with a built-in output delay circuit. Internally, a single IC consists of a voltage reference unit, a comparator, a resistor net for setting detector threshold, a manual reset circuit, an output delay circuit and an output driver transistor.

The RP300x is available in internally fixed detector threshold type. When the V_{DD} voltage becomes lower than the preset voltage, the RP300xxxxA/C generates a "L" reset signal and the RP300xxxxB (custom IC[*1]) generates a "H" reset signal. The detector threshold accuracy is as high as ±1.0% when $-V_{SET}$[*2] < 1.7 V and ±0.8% when 1.7 V ≤ $-V_{SET}$.

The reset output signal remains asserted for 50 ms, 100 ms (custom IC) or 200 ms after the V_{DD} voltage rises above the threshold voltage or when manual reset is canceled. The RP300x is designed to ignore fast transients on the V_{DD} pin. The output delay time accuracy is as high as ±5.0%.

The RP300x is available in an Nch open drain output type or in a CMOS output type.

The RP300x is offered in an ultra-small DFN(PLP)1010-4B package or in a SOT-23-5 package.

[*1] For more information about a custom IC, please contact our sales representatives.
[*2] $-V_{SET}$ is defined as a preset detector threshold.

FEATURES

- Supply Current ·· Typ. 0.95 μA ($-V_{SET}$ = 3.08 V, V_{DD} = 3.18 V)
- Operating Voltage Range ································· 0.72 V to 5.50 V (25°C)
- Detector Threshold Range ······························ 1.1 V, 2.32 V, 2.63 V, 2.7 V, 2.8 V, 2.93 V, 3.08 V, 3.4 V (34),
  4.38 V (43), 4.6 V (46)
- Detector Threshold Accuracy ···························· ±1.0% ($-V_{SET}$ < 1.7 V), ±0.8% (1.7 V ≤ $-V_{SET}$)
- Detector Threshold Temperature Coefficient··········· Typ. ±50 ppm/°C
- Released Output Delay Time ···························· Typ. 50 ms, 100 ms (custom IC), 200 ms
- Released Output Delay Time Accuracy ················ ±5% (25°C), ±15% (−40°C to 85°C)
- Package·· DFN(PLP)1010-4B, SOT-23-5
- Output Type ··· Nch Open Drain output, CMOS Output
- Reset Signal ··· Active-low, Active-high (custom IC)

APPLICATIONS

- Voltage monitoring for handheld communication equipment, camera and VCRs.
- Voltage monitoring for battery-powered equipment
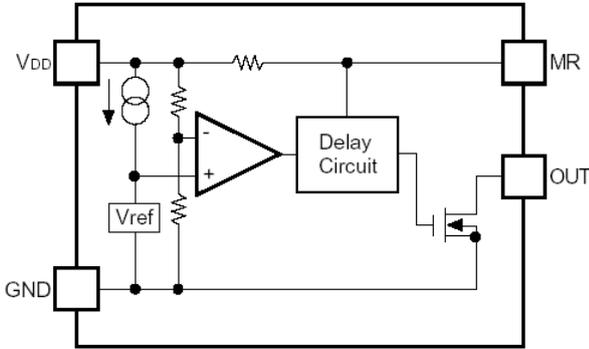
BLOCK DIAGRAMS

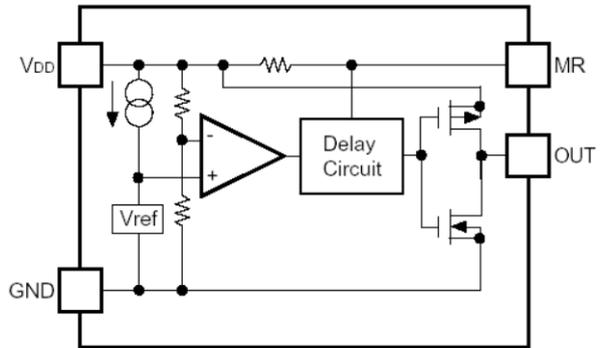**Figure 1. RP300xxxxA/B (Nch Open Drain Output)**   **Figure 2. RP300xxxxC (CMOS Output)**

SELECTION GUIDE

With the RP300x, the detector threshold, the package type, the released output delay time and the output type are user-selectable options.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP300Kxxy∗(z)-TR	DFN(PLP)1010-4B	10,000 pcs	Yes	Yes
RP300Nxxy∗(z)-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes

  xx: Specify −V_{SET} from 1.1 V (11), 2.32 V (23), 2.63 V (26), 2.7 V (27), 2.8 V (28), 2.93 V (29),
      3.08 V (30), 3.4 V (34), 4.38 V (43), 4.6 V (46).

  z: If −V_{SET} includes the 3rd digit, indicate the digit of 0.01 V.
      Ex. If −V_{SET} is 2.63 V, indicate as RP300x26xx3-TR-x.

  y: Specify the released output delay time.
      (A) 50 ms
      (B) 100 ms (custom IC)
      (D) 200 ms

  ∗: Specify the output type.
      (A) Nch Open Drain Output
      (B) Nch Open Drain Inverting Output (custom IC)
      (C) CMOS Output

RICOH

PIN CONFIGULATIONS

● **DFN(PLP)1010-4B**　　　　　● **SOT- 23-5**
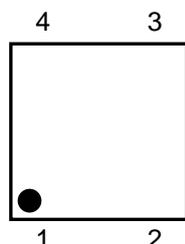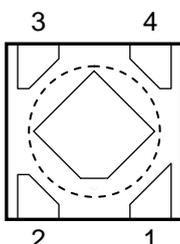
Figure 3. Top View　　**Figure 4. Bottom View**　　**Figure 5. Mark Side**
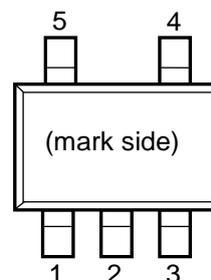
PIN DESCRIPTION

RP300K: DFN(PLP)1010-4B

Pin No.	Symbol	Pin Description
1	OUT	Output Pin RP300xxxxA/C: asserts an active-low reset signal when a voltage drops below the detector threshold. RP300xxxxB: asserts an active-high reset signal when a voltage drops below the detector threshold. (custom IC)
2	MR	Manual Reset Input Pin: active-low
3	GND	Ground Pin
4	V_{DD}	Input Pin

The tab on the bottom of the package enhances thermal performance and is electrically connected to GND (substarate level). It is recommended that the tab be connected to the ground plane on the board. If not, the tab can be left open.

RP300N: SOT-23-5

Pin No.	Symbol	Description
1	MR	Manual Reset Input Pin: active-low
2	GND	Ground Pin
3	NC	No Connection
4	OUT	Output Pin RP300xxxxA/C: asserts an active-low reset signal when a voltage drops below the detector threshold. RP300xxxxB: asserts an active-high reset signal when a voltage drops below the detector threshold. (custom IC)
5	V_{DD}	Input Pin

RICOH

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating		Unit
V_{IN}	Input Voltage	6.0		V
OUT	Output Voltage (Nch Open Drain Output)	−0.3 to 6.0		V
	Output Voltage (CMOS Output)	−0.3 to V_{DD} +0.3		
MR	Manual Reset Pin	−0.3 to V_{DD} +0.3		V
I_{OUT}	Output Current	20		mA
P_D	Power Dissipation (Standard Land Pattern)[*3]	DFN(PLP)1010-4B	400	mW
		SOT-23-5	420	
Ta	Operating Temperature Range	−40 to +85		°C
Tstg	Storage Temperature Range	−55 to +125		°C

[*3] Refer to the next page for detailed information about Power Dissipation.

ABSOLUTE MAXIMUM RATINGS
Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)
All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

RICOH

POWER DISSIPATION (DFN(PLP)1010-4B)

Power Dissipation (P_D) of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.
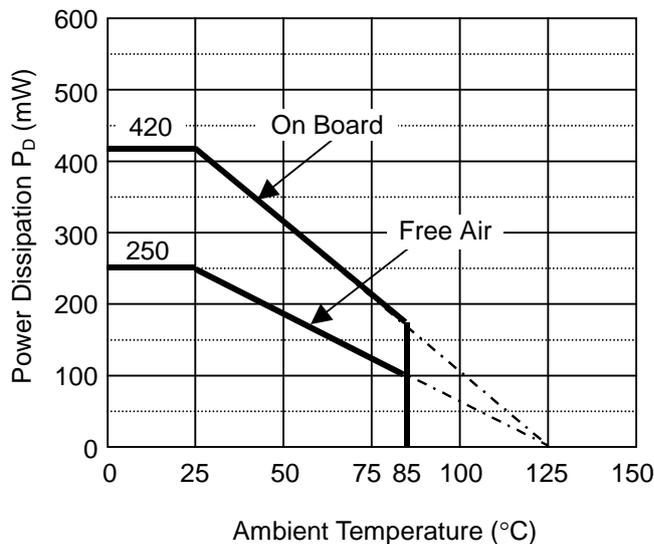
Measurement Conditions

	Standard Land Pattern
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Double-sided)
Board Dimensions	40 mm x 40 mm x 1.6 mm
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%
Through-holes	ϕ 0.54 mm x 24 pcs

Measurement Result: (Ta = 25°C, Tjmax = 125°C)

	Standard Land Pattern
Power Dissipation	400 mW
Thermal Resistance	θja = (125 −25°C) / 0.4 W = 250°C/W
	θjc = 67°C/W

Power Dissipation

Measurement Board Pattern

IC Mount Area (Unit : mm)

RICOH
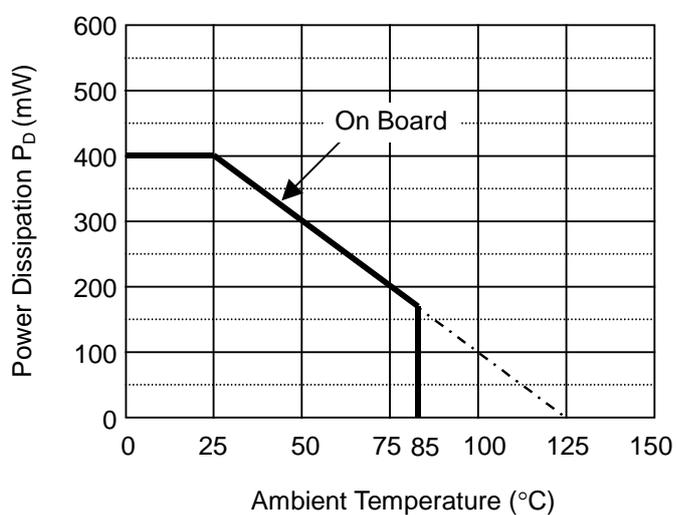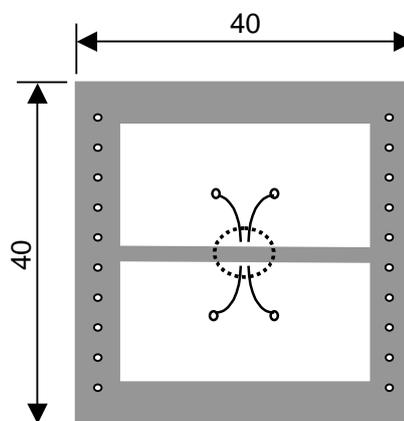
POWER DISSIPATION (SOT-23-5)

Power Dissipation (P_D) of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement. This data is taken from SOT-23-6.

Measurement Conditions

	Standard Land Pattern
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Double-sided)
Board Dimensions	40 mm x 40 mm x 1.6 mm
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%
Through-holes	ϕ 0.5 mm x 44 pcs

Measurement Result: (Ta = 25°C, Tjmax = 125°C)

	Standard Land Pattern	**Free Air**
Power Dissipation	420 mW	250 mW
Thermal Resistance	θja = (125 − 25°C) / 0.42 W = 238°C/W	400°C/W

Power Dissipation

Measurement Board Pattern

$\vdots$ IC Mount Area (Unit: mm)

RICOH
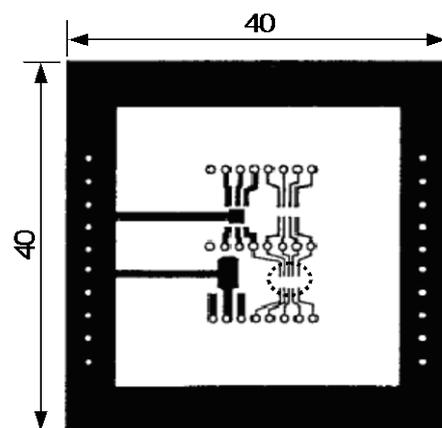
ELECTRICAL CHARACTERISTICS

The specifications surrounded by ☐ are guaranteed by design engineering at −40°C ≤ Ta ≤ 85°C.

RP300x (Ta = 25°C)

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
−V$_{DET}$*4	Detector Threshold (Ta = 25°C)	−V$_{SET}$*4 < 1.7 V		×0.99		×1.010	V
		1.7 V ≤ −V$_{SET}$		×0.992		×1.008	V
	Detector Threshold (−40°C ≤ Ta ≤ 85°C)	−V$_{SET}$ < 1.7 V		×0.982		×1.018	V
		1.7 V ≤ −V$_{SET}$		×0.984		×1.016	V
I$_{SS1}$	Supply Current 1	V$_{DD}$ = −V$_{SET}$ −0.1 V, I$_{OUT}$ = 0 A				3.2	μA
I$_{SS2}$	Supply Current 2	V$_{DD}$ = −V$_{SET}$ +0.1 V, I$_{OUT}$ = 0 A				3.1	μA
V$_{DD}$	Operating Voltage	Ta = 25°C		0.72		5.5	V
		−40°C ≤ Ta ≤ 85°C		0.80		5.5	V
I$_{OUT}$	Output Current (Driver Output Pin)	Nch V$_{DD}$ = −V$_{SET}$ −0.1 V V$_{DS}$ = 0.3 V	−V$_{SET}$ ≥ 1.1 V	0.45			mA
			−V$_{SET}$ ≥ 1.6 V	2.5			mA
			−V$_{SET}$ ≥ 2.7 V	4.8			mA
		Nch Inverting*5 V$_{DD}$ = −V$_{SET}$ +0.1 V V$_{DS}$ = 0.3 V	−V$_{SET}$ ≥ 1.1 V	0.45			mA
			−V$_{SET}$ ≥ 1.4 V	2.5			mA
			−V$_{SET}$ ≥ 2.5 V	4.8			mA
		Pch CMOS V$_{DD}$ = −V$_{SET}$ +0.1 V V$_{DS}$ = −0.3 V	−V$_{SET}$ ≥ 1.1 V	−0.15			mA
			−V$_{SET}$ ≥ 1.6 V	−0.45			mA
			−V$_{SET}$ ≥ 2.7 V	−0.8			mA
I$_{LEAK}$	Nch Driver Leakage Current	V$_{DD}$ = 5.5 V V$_{DS}$ = 5.5 V	RP300xxxxA/C			0.15	μA
		V$_{DD}$ = −V$_{SET}$ −0.1 V V$_{DS}$ = 5.5 V	RP300xxxxB*6				
R$_{MR}$	MR Pin Pull-up Resistance			0.21	0.45	0.90	MΩ
V$_{IH}$	MR Pin Input Voltage "H"	V$_{DD}$ ≥ −V$_{SET}$ +0.1 V		0.75 ×V$_{DD}$			V
V$_{IL}$	MR Pin Input Voltage "L"	V$_{DD}$ ≥ −V$_{SET}$ +0.1 V				0.4	V
tdelay*8	Released Output Delay Time	V$_{DD}$ = 0.8 V → −V$_{SET}$ +1.0 V	RP300xxxAx	47.5	50	52.5	ms
			RP300xxxBx*7	95	100	105	ms
			RP300xxxDx	190	200	210	ms
		−40°C ≤ Ta ≤ 85°C		tset*8 ×0.85		tset× 1.15	%
Δ−V$_{DET}$ /ΔTa	Detector Threshold Temperature Coefficient	−40°C ≤ Ta ≤ 85°C			±50		ppm /°C

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj ≈ Ta = 25°C) except Detector Threshold Temperature Coefficient.

*4 −V$_{DET}$ is defined as an actual detector threshold and −V$_{SET}$ is defined as a preset detector threshold.

*5 Nch open drain inverting output type is only applicable to the RP300xxxxB which is a custom IC.

*6 The RP300xxxxB is a custom IC. *7 The RP300xxxBx is a custom IC.

*8 tdelay is defined as an actual released output delay time and tset is defined as a preset released output delay time.

RICOH

TIMING CHART

Detector Threshold
= Release Voltage (V$_{DET}$)

Power Supply
Voltage (V$_{DD}$)

Min. Operating Voltage

GND

Manual Reset

GND

V$_{PULLUP}$

Output Voltage (V$_{OUT}$)

GND
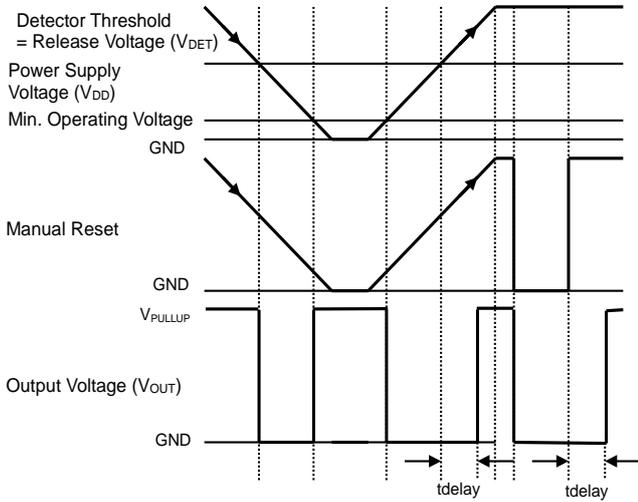
tdelay   tdelay

Figure 6. RP300xxxxA Timing Chart

Detector Threshold
= Release Voltage (V$_{DET}$)

Power Supply
Voltage (V$_{DD}$)

Min. Operating Voltage

GND

Manual Reset

GND

V$_{PULLUP}$

Output Voltage (V$_{OUT}$)

GND
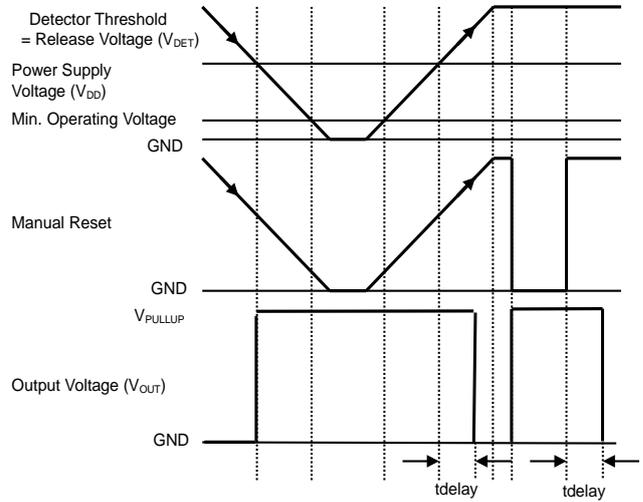
tdelay   tdelay

Figure 7. RP300xxxxB Timing Chart

Detector Threshold
= Release Voltage (V$_{DET}$)

Power Supply
Voltage (V$_{DD}$)

Min. Operating Voltage

GND

Manual Reset

GND

V$_{OUT}$

Unstable Area

Output Voltage (V$_{OUT}$)

GND
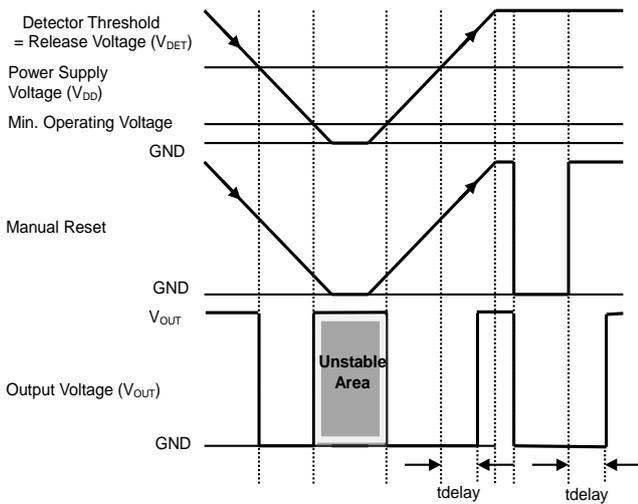
tdelay   tdelay

Figure 8. RP300xxxxC Timing Chart

RICOH

Release Output Delay Time (tdelay)

tdelay is defined as follows.

1. Nch Open Drain Output

   Release output delay time starts after the OUT pin is pulled up to 5.5 V with a 470 kΩ resistor, and the V_{DD} voltage is shifted from 0.8 V to $-V_{SET}$ + 1.0 V. It ends when the output voltage reaches 1.0 V.

2. Nch Open Drain Inverting Output (custom IC)

   Release output delay time starts after the OUT pin is pulled up to 5.5 V with a 470 kΩ resistor, and the V_{DD} voltage is shifted from 0.8 V to $-V_{SET}$ + 1.0 V. It ends when the output voltage reaches V_{DD} / 2 V.

3. CMOS Output

   Release output delay time starts when the V_{DD} voltage is shifted from 0.8 V to $-V_{SET}$ + 1.0 V and ends when the output voltage reaches V_{DD} / 2 V.
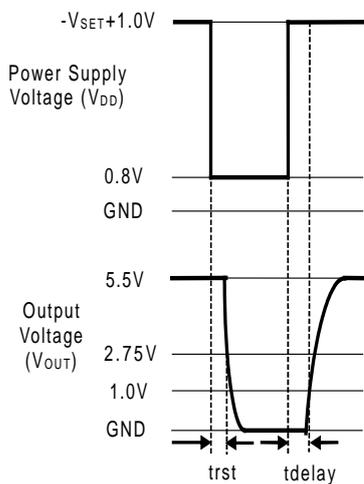
Figure 9. Nch Open Drain Output
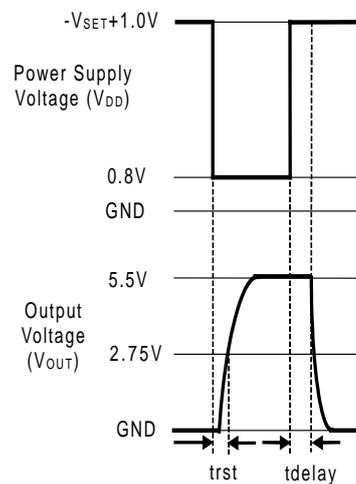
Figure 10. Nch Open Drain Inverting Output
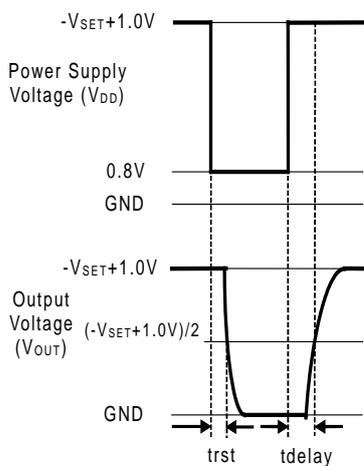
Figure 11. CMOS Output

RICOH

THEORY OF OPERATION

RP300xxxxA/C
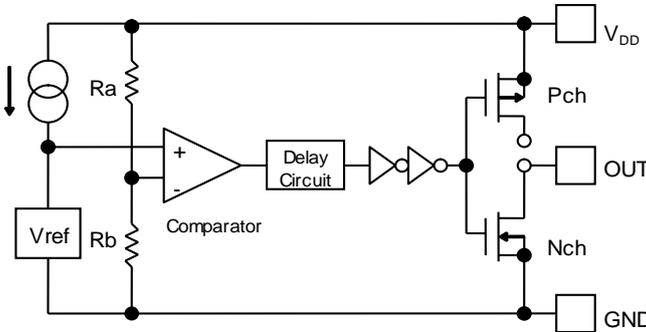
Figure 12. Block Diagram

- ・ For CMOS Output, the Nch Tr. drain and the Pch Tr. drain are connected to the OUT pin inside the IC.
- ・ For Nch Open Drain Output, the Nch Tr. drain is connected to the OUT pin inside the IC. Pull up the OUT pin or V_{DD} pin to the external voltage level.
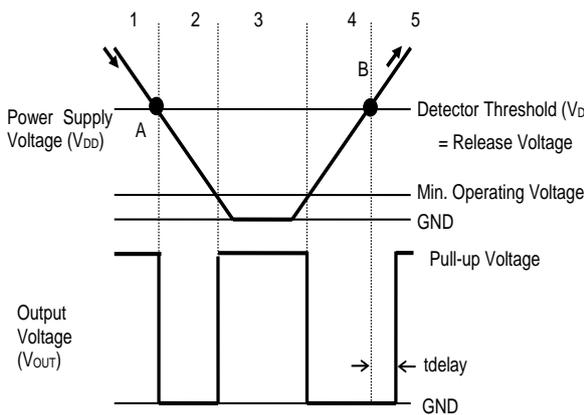
Figure 13. Timing Chart (A Ver.)
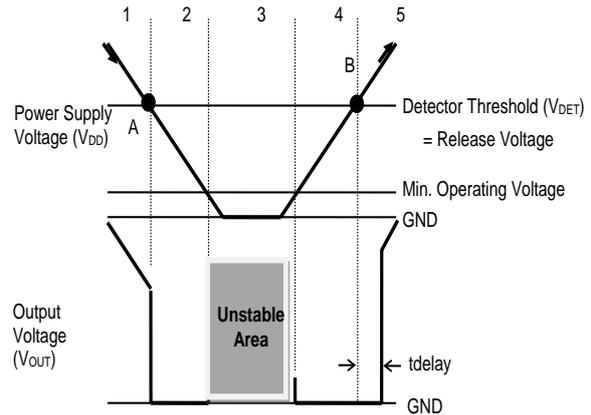
Figure 14. Timing Chart (C Ver.)

1. The output voltage is equalized to the V_{DD} voltage (CMOS Output), or to the pull-up voltage (Nch Open Drain Output).
2. The V_{DD} voltage drops to the detector threshold (A point) which means $Vref \geq V_{DD} \times Rb / (Ra + Rb)$. The comparator output shifts from "L" to "H" voltage and the output voltage will be equalized to the GND voltage.
3. If the V_{DD} voltage is lower than the minimum operating voltage, the output voltage becomes unstable (CMOS Output). The output voltage is equalized to the pull-up voltage (Nch Open Drain Output).
4. The output voltage is equalized to the GND voltage.
5. The V_{DD} voltage becomes higher than the release voltage (B point) which means $Vref < V_{DD} \times Rb / (Ra + Rb)$, and the comparator output shifts from "H" to "L" voltage, and the output voltage is equalized to the V_{DD} voltage (CMOS Output) or to the pull-up voltage (Nch Open Drain Output).

   Note: There's no hysteresis between the V_{DD} voltage and the released voltage.

RICOH

RP300xxxxB
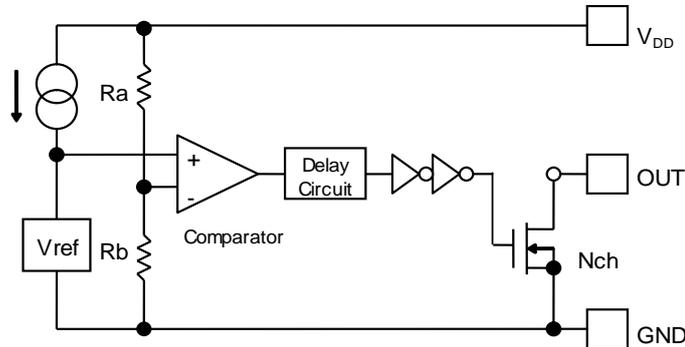
Figure 15. Block Diagram

・ The Nch Tr. drain is connected to the OUT pin inside the IC. Pull up the OUT pin or V_{DD} pin to the external voltage level.
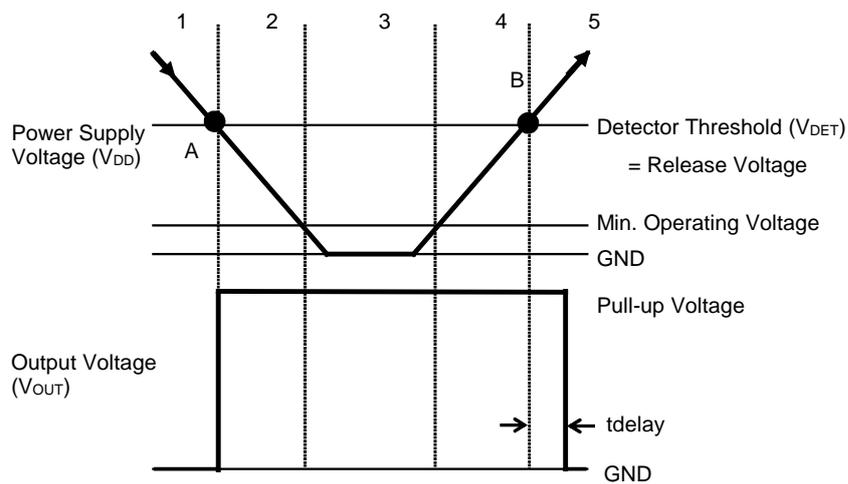
Figure 16. Timing Chart

1. The output voltage is equalized to the GND voltage.
2. The V_{DD} voltage drops to the detector threshold (A point) which means $Vref \geq V_{DD} \times Rb / (Ra + Rb)$. The comparator output shifts from "H" to "L" voltage and the output voltage shifts from the pull-up voltage to "L" voltage.
3. If the V_{DD} voltage is lower than the minimum operating voltage, the output voltage is equalized to the pull-up voltage.
4. The output voltage is equalized to the pull-up voltage.
5. The V_{DD} voltage becomes higher than the release voltage (B point) which means $Vref < V_{DD} \times Rb / (Ra + Rb)$. The comparator output shifts from "L" to "H" voltage, and the output voltage is equalized to the GND voltage.
   Note: There's no hysteresis between the V_{DD} voltage and the released voltage.

RICOH

Detector Operation vs. Glitch Input Voltage

The RP300x has built-in rejection of fast transients on the V_{DD} pins. The rejection of transients depends on both the duration and the amplitude of the transient. The amplitude of the transient is measured from the bottom of the transient to the negative threshold voltage of the RP300x, as shown in Figure 18.

Glitch Resistance Test
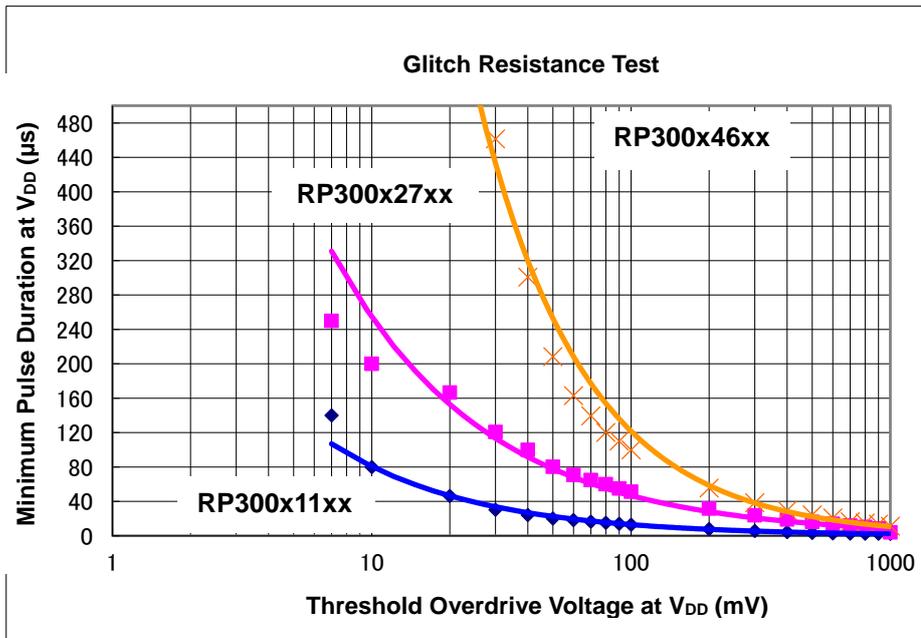
Figure 17. Minimum Pulse Duration at V_{DD} vs. Overdrive Voltage at V_{DD}
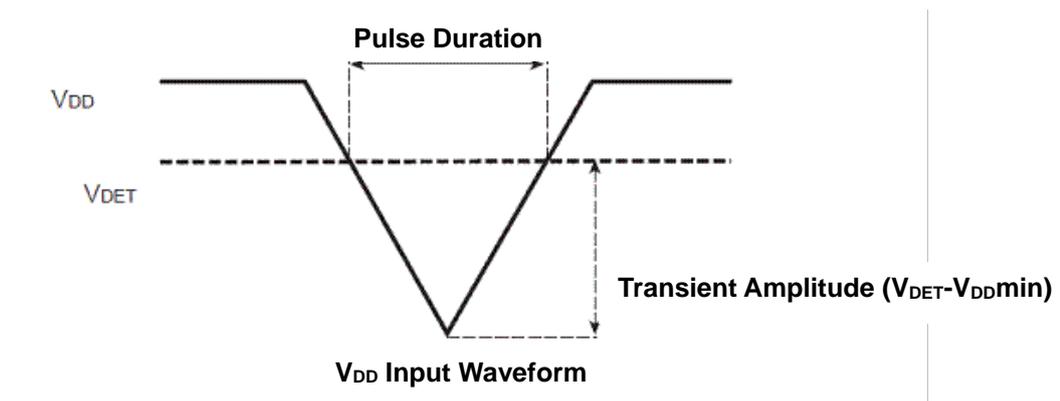
Figure 18. Voltage Transient Measurement

The RP300x does not respond to transients that are fast duration/ low amplitude or long duration/ small amplitude. Figure 17 shows the relationship between the transient amplitude and duration needed to trigger a reset. Any combination of duration and amplitude above the curve generates a reset signal.

RICOH
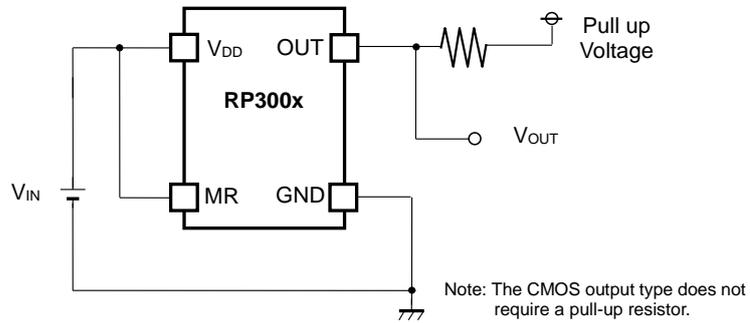
TEST CIRCUITS

Figure 19. Basic Test Circuit
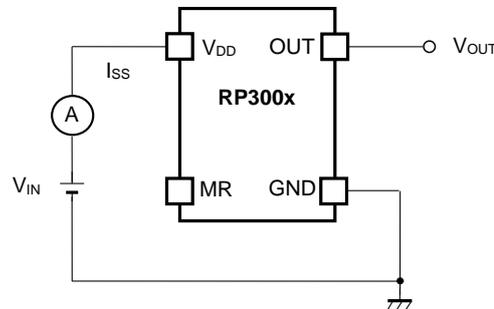
Figure 20. Test Circuit for Supply Current
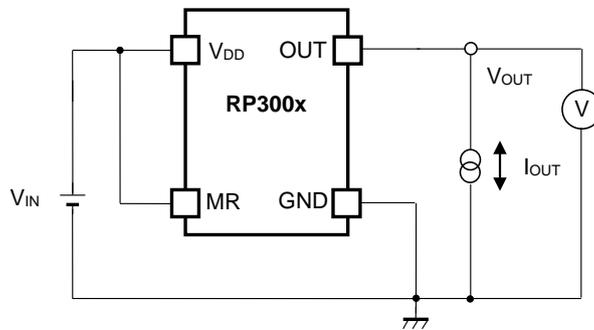
Figure 21. Test Circuit for Output Current
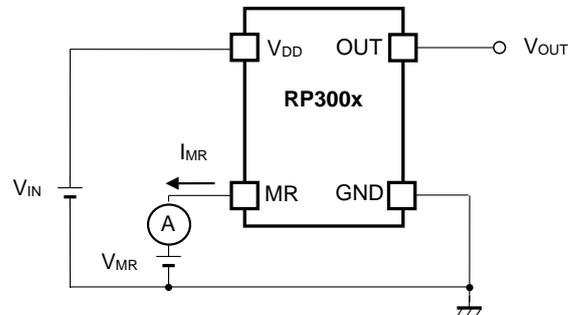
Figure 22. MR Pin Pull-up Resistor

RICOH

TYPICAL CHARACTERISTICS

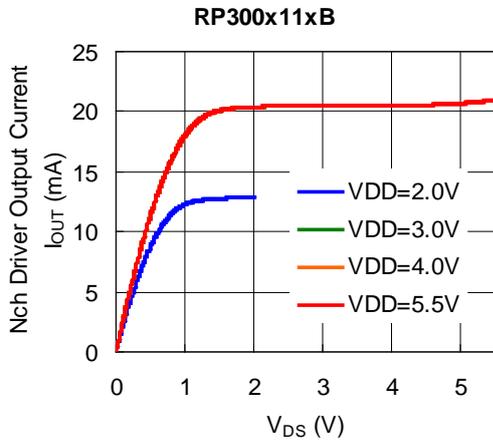## 1) Supply Current vs. Input Voltage

RP300x11xx

RP300x23xx2

RP300x30xx8

RP300x46xx
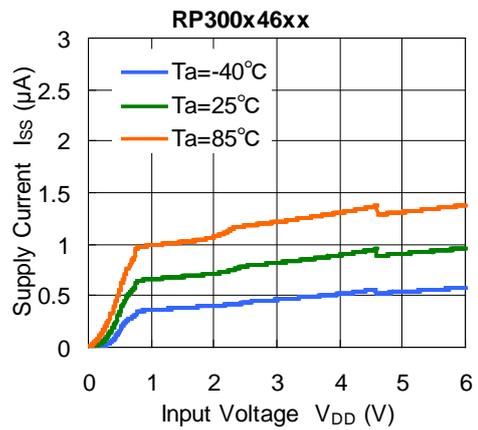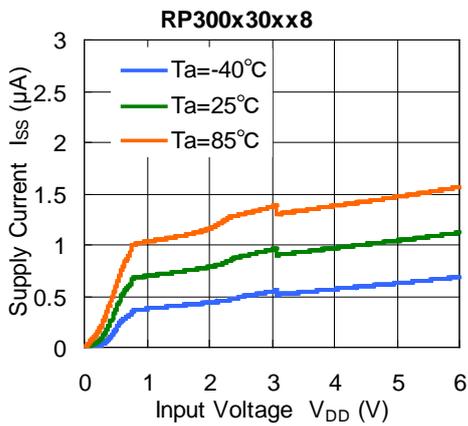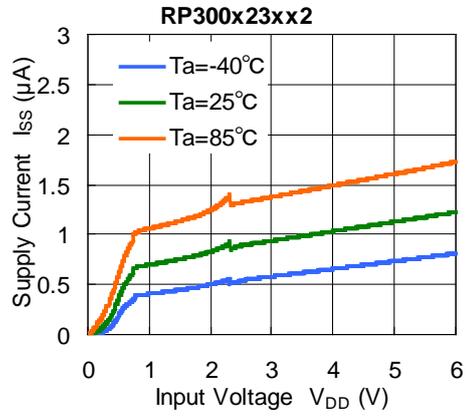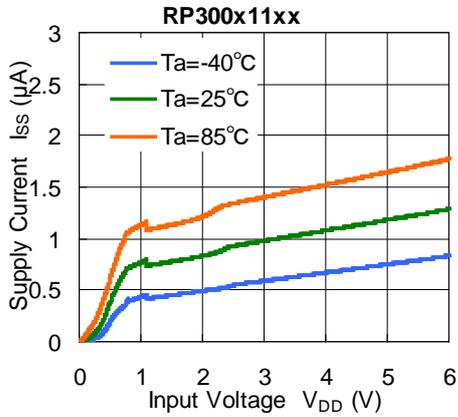
2) Detector Threshold vs. Temperature
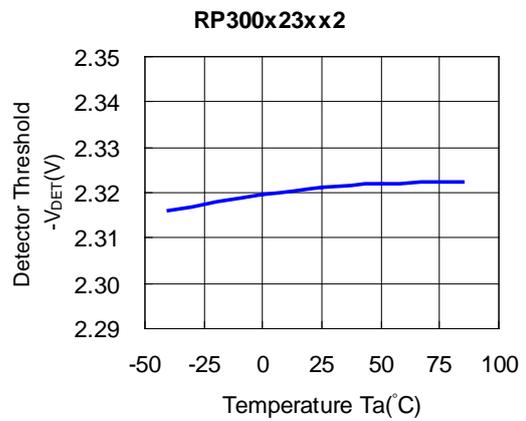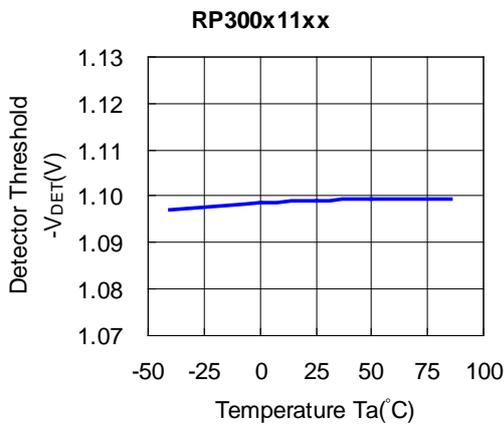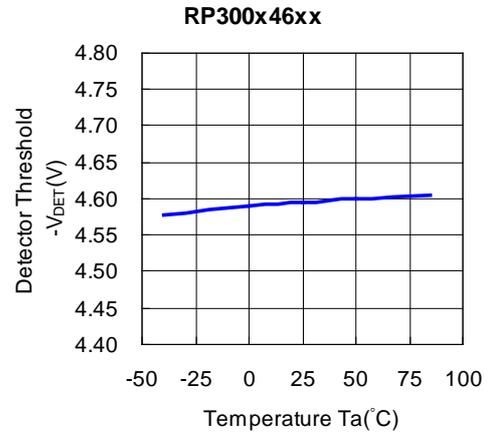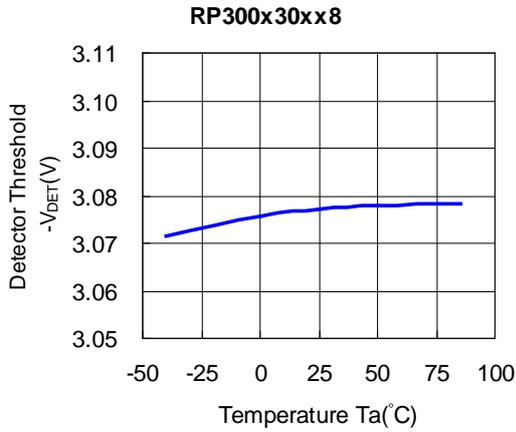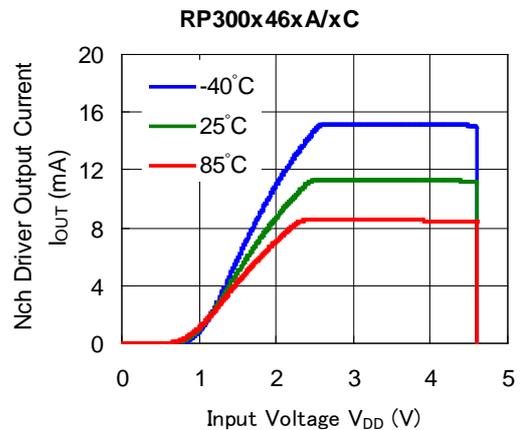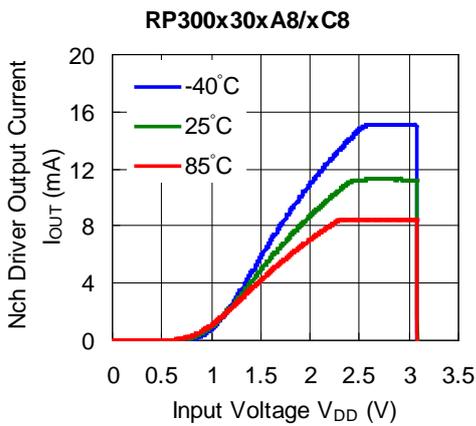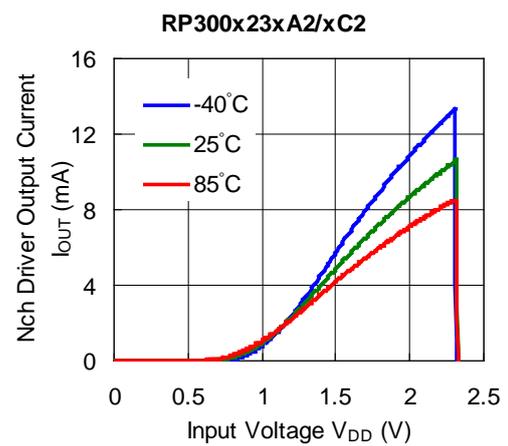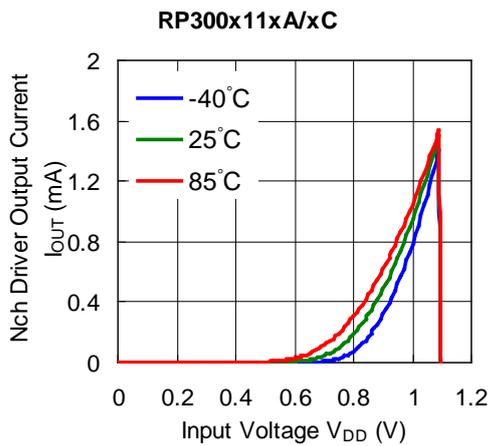
RP300x11xx

RP300x23xx2

RICOH

RP300x30xx8

RP300x46xx

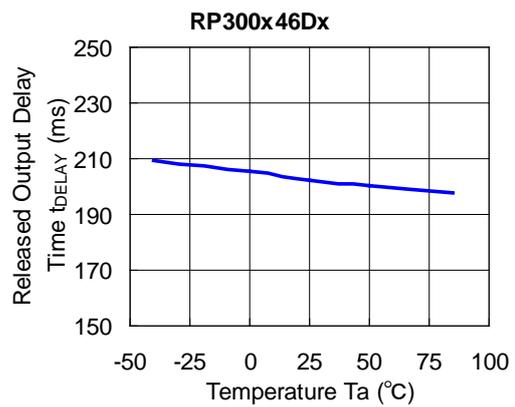## 3) Nch Driver Output Current vs. Input Voltage
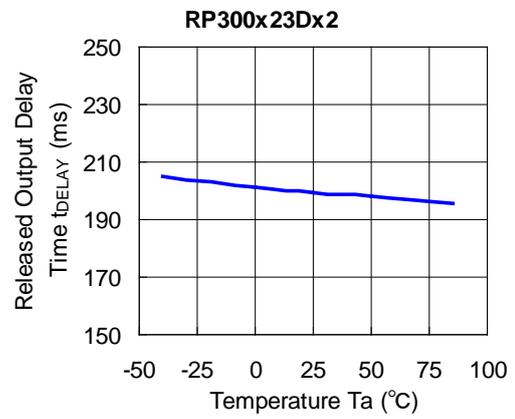
RP300x11xA/xC

RP300x23xA2/xC2

RP300x30xA8/xC8

RP300x46xA/xC

RICOH

Nch Driver Inverting Output (custom IC)

RP300x11xB

RP300x23xB2

RP300x30xB8

RP300x46xB

4) Pch Driver Output Current vs. Input Voltage

RP300x11xC
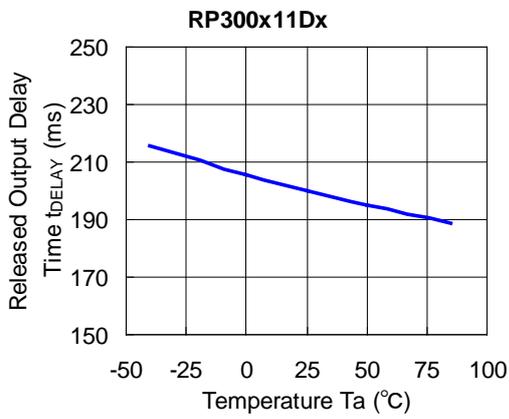

RP300x23xC2

RICOH

RP300x30xC8

RP300x46xC

5) Nch Driver Output Current vs. V_{DS}

RP300x11xA/xC

RP300x23xA2/xC2

RP300x30xA8/xC8

RP300x46xA/xC

RICOH

Nch Driver Inverting Output (custom IC)

RP300x11xB

RP300x23xB2

RP300x30xB8

RP300x46xB
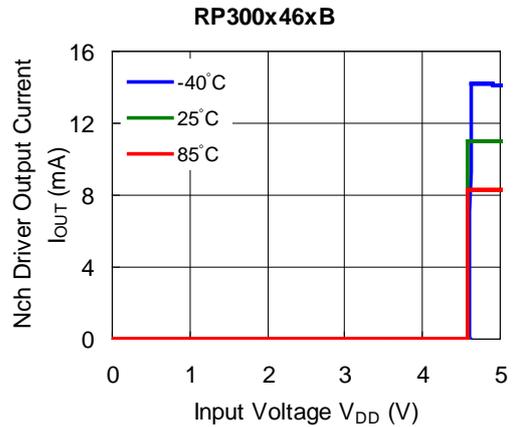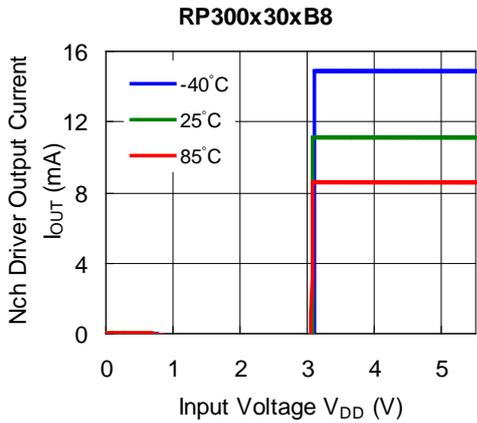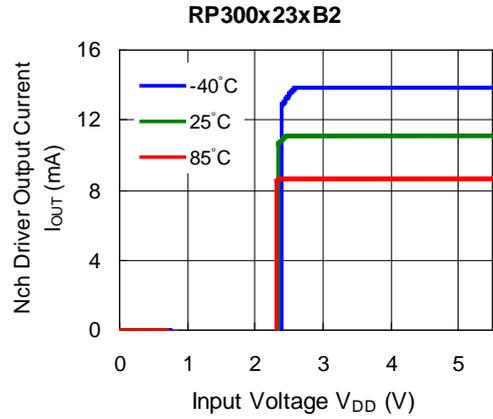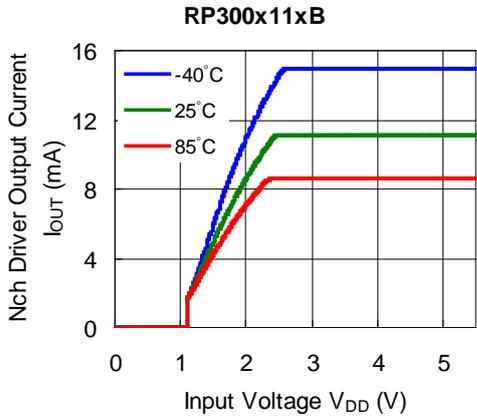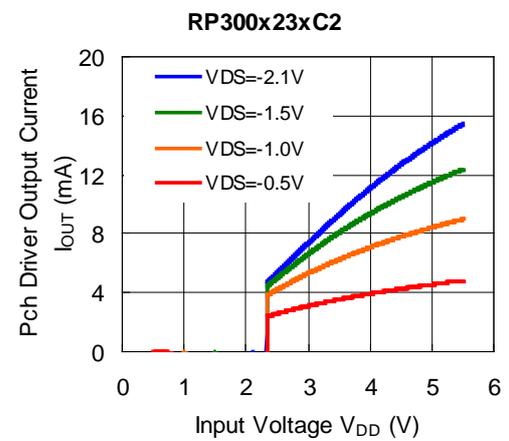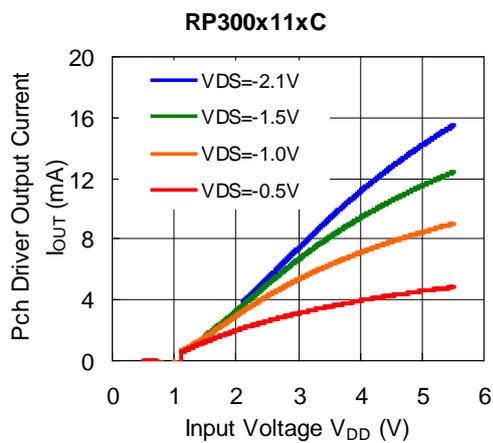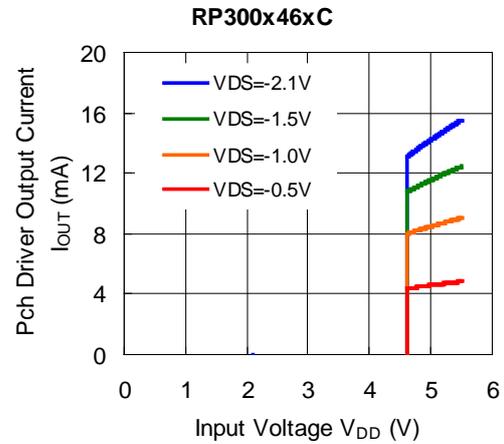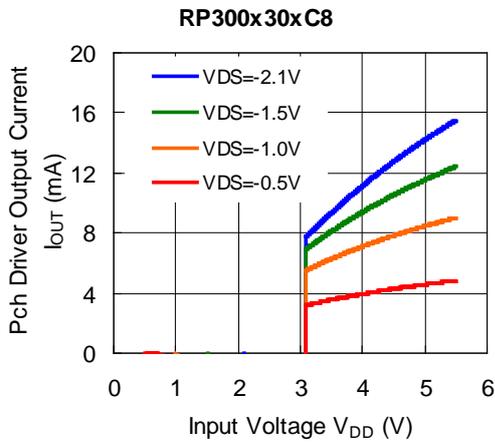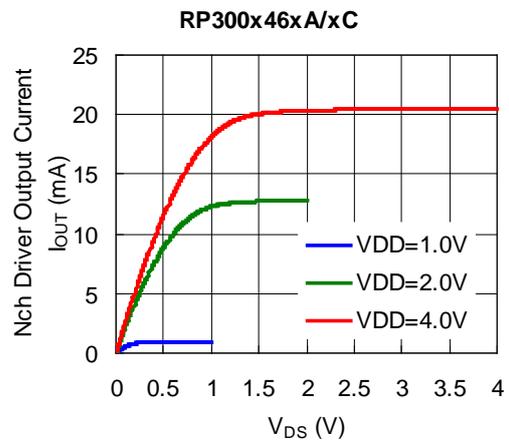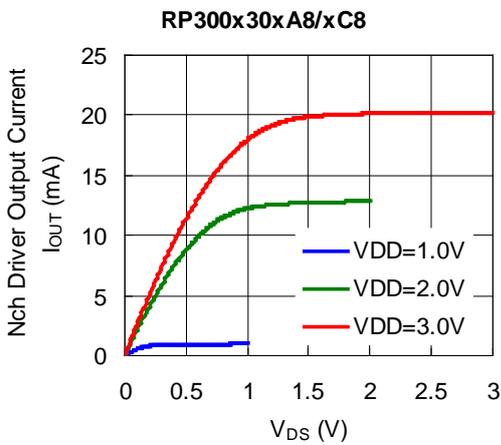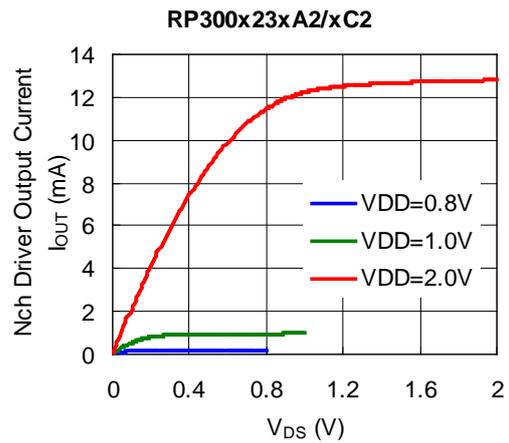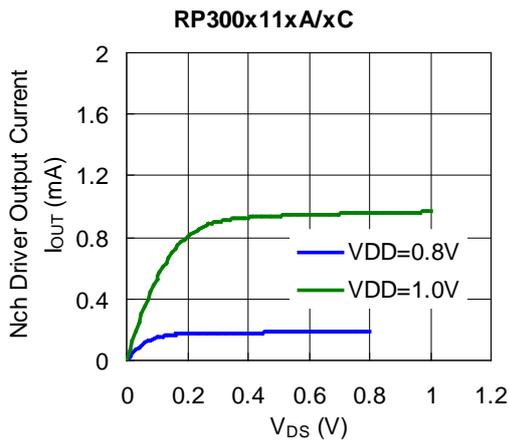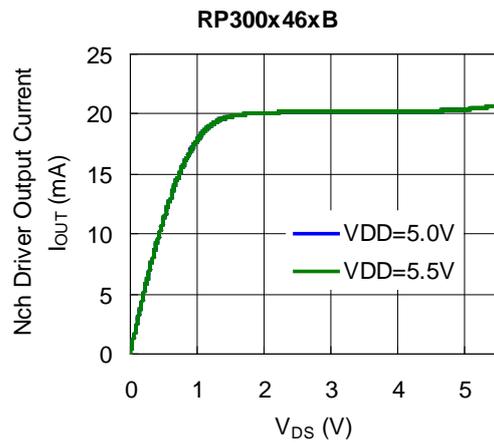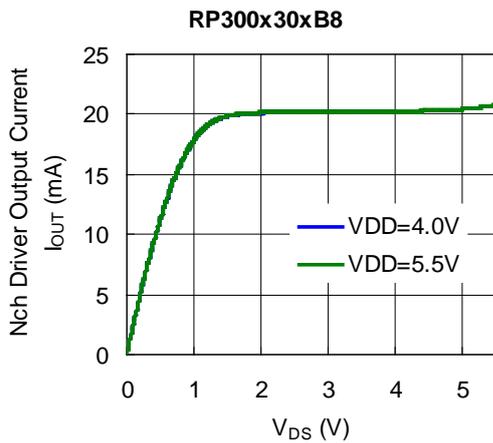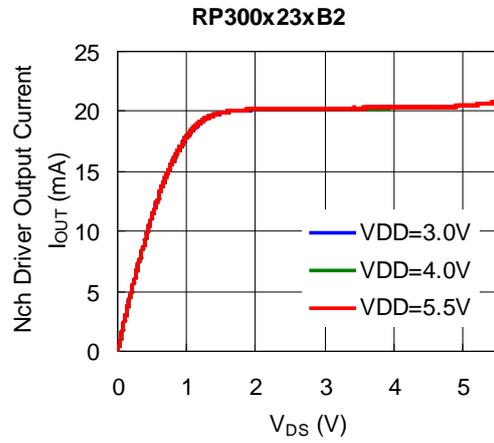
6) Released Output Delay Time vs. Temperature

RP300x11Ax

RP300x23Ax2

RICOH

RP300x30Ax8

Released Output Delay Time t_{DELAY} (ms) vs. Temperature Ta (℃)

RP300x46Ax

Released Output Delay Time t_{DELAY} (ms) vs. Temperature Ta (℃)

RP300x11Dx

Released Output Delay Time t_{DELAY} (ms) vs. Temperature Ta (℃)

RP300x23Dx2

Released Output Delay Time t_{DELAY} (ms) vs. Temperature Ta (℃)

RP300x30Dx8

Released Output Delay Time t_{DELAY} (ms) vs. Temperature Ta (℃)

RP300x46Dx

Released Output Delay Time t_{DELAY} (ms) vs. Temperature Ta (℃)

RICOH

TECHNICAL NOTES

When connecting resistors to the device's input pin

When connecting a resistor (R1) to an input of this device, the input voltage decreases by [Device's Consumption Current] x [Resistance Value] only. And, the cross conduction current[1], which occurs when changing from the detecting state to the release state, is decreased the input voltage by [Cross Conduction Current] x [Resistance Value] only. And then, this device will enter the re-detecting state if the input voltage reduction is larger than the difference between the detector voltage and the released voltage.

When the input resistance value is large and the VDD is gone up at mildly in the vicinity of the released voltage, repeating the above operation may result in the occurrence of output.

As shown in Figure A/B, set R1 to become 100 kΩ or less as a guide, and connect C_{IN} of 0.1 µF and more to between the input pin and GND. Besides, make evaluations including temperature properties under the actual usage condition, with using the evaluation board like this way. As a result, make sure that the cross conduction current has no problem.
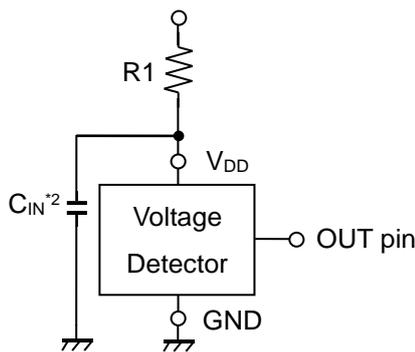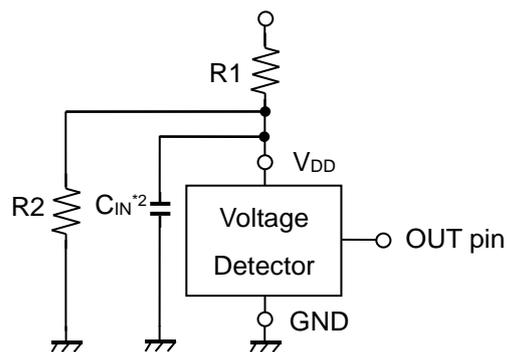

Figure A   Figure B

[1] In the CMOS output type, a charging current for OUT pin is included.

[2] Note the bias dependence of capacitors.

RICOH

RoHS Compliant
Halogen Free

Ricoh is committed to reducing the environmental loading materials in electrical devices with a view to contributing to the protection of human health and the environment.
Ricoh has been providing RoHS compliant products since April 1, 2006 and Halogen-free products since April 1, 2012.

RICOH RICOH ELECTRONIC DEVICES CO., LTD.

http://www.e-devices.ricoh.co.jp/en/

Sales & Support Offices

RICOH ELECTRONIC DEVICES CO., LTD.
Higashi-Shinagawa Office (International Sales)
3-32-3, Higashi-Shinagawa, Shinagawa-ku, Tokyo 140-8655, Japan
Phone: +81-3-5479-2857 Fax: +81-3-5479-0502

RICOH EUROPE (NETHERLANDS) B.V.
Semiconductor Support Centre
Prof. W.H. Keesomlaan 1, 1183 DJ Amstelveen, The Netherlands
Phone: +31-20-5474-309

RICOH INTERNATIONAL B.V. - German Branch
Semiconductor Sales and Support Centre
Oberrather Strasse 6, 40472 Düsseldorf, Germany
Phone: +49-211-6546-0

RICOH ELECTRONIC DEVICES KOREA CO., LTD.
3F, Haesung Bldg, 504, Teheran-ro, Gangnam-gu, Seoul, 135-725, Korea
Phone: +82-2-2135-5700 Fax: +82-2-2051-5713

RICOH ELECTRONIC DEVICES SHANGHAI CO., LTD.
Room 403, No.2 Building, No.690 Bibo Road, Pu Dong New District, Shanghai 201203, People's Republic of China
Phone: +86-21-5027-3200 Fax: +86-21-5027-3299

RICOH ELECTRONIC DEVICES CO., LTD.
Taipei office
Room 109, 10F-1, No.51, Hengyang Rd., Taipei City, Taiwan (R.O.C.)
Phone: +886-2-2313-1621/1622 Fax: +886-2-2313-1623

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information: